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Team Nexperia

Quad 2-input NAND Schmitt trigger Rev. 4 — 1 December 2015

Product data sheet

General description 1.

The 74HC132; 74HCT132 is a quad 2-input NAND gate with Schmitt-trigger inputs. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V_{CC} . Schmitt trigger inputs transform slowly changing input signals into sharply defined jitter-free output signals.

Features and benefits 2.

- Complies with JEDEC standard no. 7A
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C

Applications 3.

- Wave and pulse shapers
- Astable multivibrators
- Monostable multivibrators

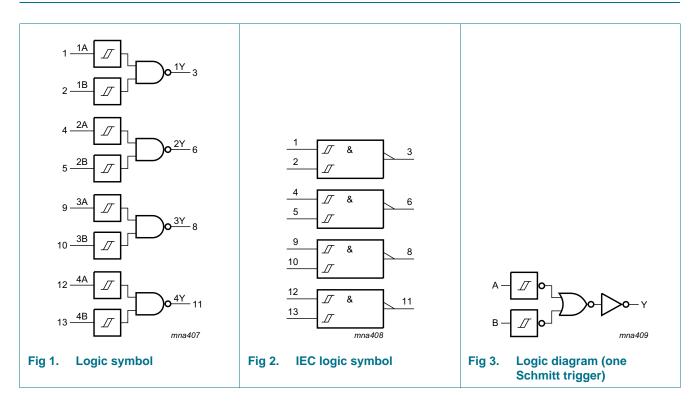


4. Ordering information

Table 1. Ordering information

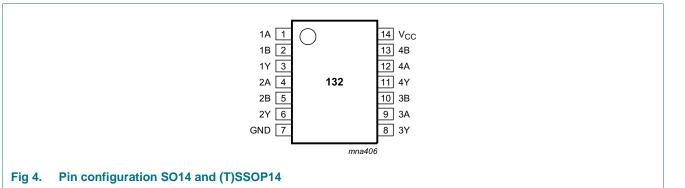
Type number	Package			
	Temperature range	Name	Description	Version
74HC132D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads; body width	SOT108-1
74HCT132D			3.9 mm	
74HC132DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body	SOT337-1
74HCT132DB			width 5.3 mm	
74HC132PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1
74HCT132PW	1		body width 4.4 mm	

5. Functional diagram



6. Pinning information

6.1 Pinning



6.2 Pin description

Table 2. **Pin description** Symbol Pin Description 1A to 4A 1, 4, 9, 12 data input 1B to 4B 2, 5, 10, 13 data input 1Y to 4Y 3, 6, 8, 11 data output GND 7 ground (0 V) 14 supply voltage V_{CC}

7. Functional description

Table 3.Function table [1]

Input	Output	
nA	nB	nY
L	L	Н
L	Н	Н
Н	L	Н
Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage			-0.5	+7	V
I _{IK}	input clamping current	V_{I} < -0.5 V or V_{I} > V_{CC} + 0.5 V	<u>[1]</u>	-	±20	mA
I _{ОК}	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u>	-	±20	mA
I _O	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I _{CC}	supply current			-	50	mA
I _{GND}	ground current			-50	-	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	SO14, and (T)SSOP14 packages	[2]	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SO14 package: P_{tot} derates linearly with 8 mW/K above 70 °C.
 For (T)SSOP14 packages: P_{tot} derates linearly with 5.5 mW/K above 60 °C.

9. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions	74HC132		74HCT132			Unit	
			Min	Тур	Max	Min	Тур	Max	
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V _{CC}	0	-	V _{CC}	V
Vo	output voltage		0	-	V _{CC}	0	-	V _{CC}	V
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C

Quad 2-input NAND Schmitt trigger

10. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C t	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC13	2									
V _{OH}	HIGH-level	$V_{I} = V_{T+} \text{ or } V_{T-}$								
	output voltage	$I_0 = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O} = -5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL} LOW-level	$V_{I} = V_{T+} \text{ or } V_{T-}$									
	output voltage	$I_{O} = 20 \ \mu A; V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 4.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_0 = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0 V$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 6.0$ V	-	-	2.0	-	20	-	40	μΑ
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT1	32									4
V _{OH}	HIGH-level	$V_{I} = V_{T+} \text{ or } V_{T-}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I _O = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V _{OL}	LOW-level	$V_{I} = V_{T+} \text{ or } V_{T-}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I _O = 20 μA;	-	0	0.1	-	0.1	-	0.1	V
		l _O = 4.0 mA;	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_1 = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1.0	-	±1.0	μΑ
I _{CC}	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A; $V_{CC} = 5.5$ V	-	-	2.0	-	20	-	40	μΑ
∆l _{CC}	additional supply current	per input pin; $V_I = V_{CC} - 2.1 \text{ V}; I_O = 0 \text{ A};$ other inputs at V_{CC} or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	30	108	-	135	-	147	μA
Cı	input capacitance		-	3.5	-	-	-	-	-	pF

Quad 2-input NAND Schmitt trigger

11. Dynamic characteristics

Table 7. Dynamic characteristics

GND = 0 V; $C_L = 50$ pF; for load circuit see <u>Figure 6</u>.

Symbol	Parameter	Conditions			25 °C		–40 °C to	o +125 °C	Unit
				Min	Тур	Max	Max (85 °C)	Max (125 °C)	
74HC132	2								
propagation delay nA, nB to nY; see Figure 5		<u>[1]</u>							
		V _{CC} = 2.0 V		-	36	125	155	190	ns
		V _{CC} = 4.5 V		-	13	25	31	38	ns
		V _{CC} = 5.0 V; C _L = 15 pF		-	11	-	-	-	ns
		V _{CC} = 6.0 V		-	10	21	26	32	ns
t _t	transition time	see Figure 5	[2]						
		V _{CC} = 2.0 V		-	19	75	95	110	ns
		V _{CC} = 4.5 V		-	7	15	19	22	ns
		V _{CC} = 6.0 V		-	6	13	16	19	ns
C _{PD}	power dissipation capacitance	per package; $V_I = GND$ to V_{CC}	<u>[3]</u>	-	24	-	-	-	pF
74HCT1	32					-	-	-	-
t _{pd}	propagation delay	nA, nB to nY; see Figure 5	<u>[1]</u>						
		V _{CC} = 4.5 V		-	20	33	41	50	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	17	-	-	-	ns
tt	transition time	$V_{CC} = 4.5 \text{ V}; \text{ see } \frac{\text{Figure 5}}{1000}$	[2]	-	7	15	19	22	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC} – 1.5 V	<u>[3]</u>	-	20	-	-	-	pF

[1] t_{pd} is the same as t_{PHL} and t_{PLH} .

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W):

 $P_{D} = C_{PD} \times V_{CC}^{2} \times f_{i} \times N + \sum (C_{L} \times V_{CC}^{2} \times f_{o}) \text{ where:}$

 f_i = input frequency in MHz;

 $f_o =$ output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

N = number of inputs switching;

 \sum (C_L \times V_{CC}^2 \times f_o) = sum of outputs.

Quad 2-input NAND Schmitt trigger

12. Waveforms

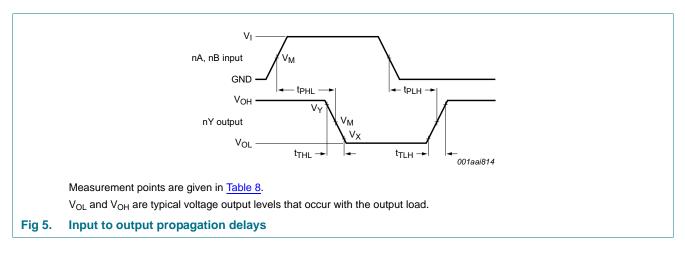
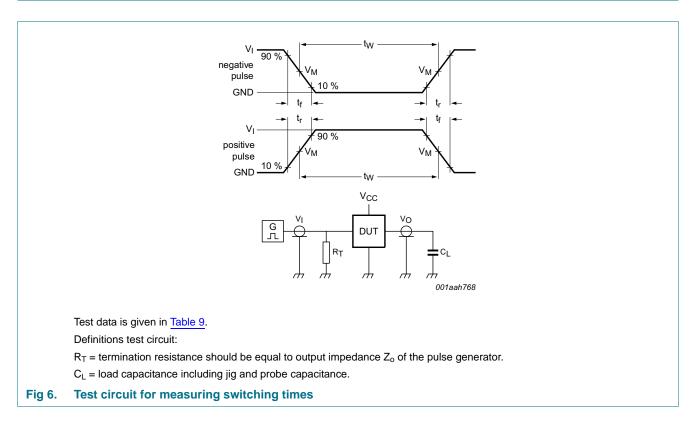


Table 8.Measurement points

Туре	Input	Output				
	V _M	V _M V _X V _Y				
74HC132	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}		
74HCT132	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}		



	Tab	le 9.	Test data
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Туре	Input		Load	Test
	VI	t _r , t _f	CL	
74HC132	V _{CC}	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}
74HCT132	3.0 V	6.0 ns	15 pF, 50 pF	t _{PLH} , t _{PHL}

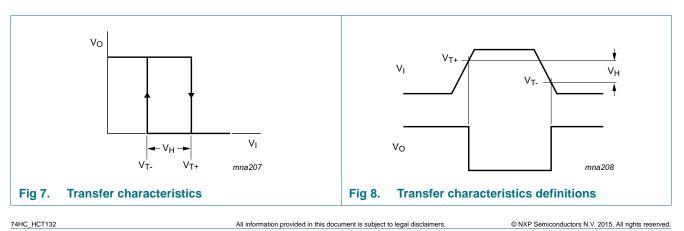
13. Transfer characteristics

Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see <u>Figure 7</u> and <u>Figure 8</u>.

Symbol	Parameter	Conditions	T _{ar}	_{mb} = 25	°C		- –40 °C 85 °C		= –40 °C 125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC13	2	I					1	1		
V _{T+}	positive-going	V _{CC} = 2.0 V	0.7	1.18	1.5	0.7	1.5	0.7	1.5	V
	threshold	V _{CC} = 4.5 V	1.7	2.38	3.15	1.7	3.15	1.7	3.15	V
	voltage	V _{CC} = 6.0 V	2.1	3.14	4.2	2.1	4.2	2.1	4.2	V
V _{T-}	negative-going	V _{CC} = 2.0 V	0.3	0.63	1.0	0.3	1.0	0.3	1.0	V
	threshold	V _{CC} = 4.5 V	0.9	1.67	2.2	0.9	2.2	0.9	2.2	V
	voltage	V _{CC} = 6.0 V	1.2	2.26	3.0	1.2	3.0	1.2	3.0	V
V _H	hysteresis	V _{CC} = 2.0 V	0.2	0.55	1.0	0.2	1.0	0.2	1.0	V
	voltage	V _{CC} = 4.5 V	0.4	0.71	1.4	0.4	1.4	0.4	1.4	V
		V _{CC} = 6.0 V	0.6	0.88	1.6	0.6	1.6	0.6	1.6	V
74HCT1	32	l					1		<u> </u>	
V _{T+}	positive-going	V _{CC} = 4.5 V	1.2	1.41	1.9	1.2	1.9	1.2	1.9	V
	threshold voltage	V _{CC} = 5.5 V	1.4	1.59	2.1	1.4	2.1	1.4	2.1	V
V _{T-}	negative-going	V _{CC} = 4.5 V	0.5	0.85	1.2	0.5	1.2	0.5	1.2	V
	threshold voltage	V _{CC} = 5.5 V	0.6	0.99	1.4	0.6	1.4	0.6	1.4	V
V _H	hysteresis	V _{CC} = 4.5 V	0.4	0.56	-	0.4	-	0.4	-	V
	voltage	V _{CC} = 5.5 V	0.4	0.60	-	0.4	-	0.4	-	V

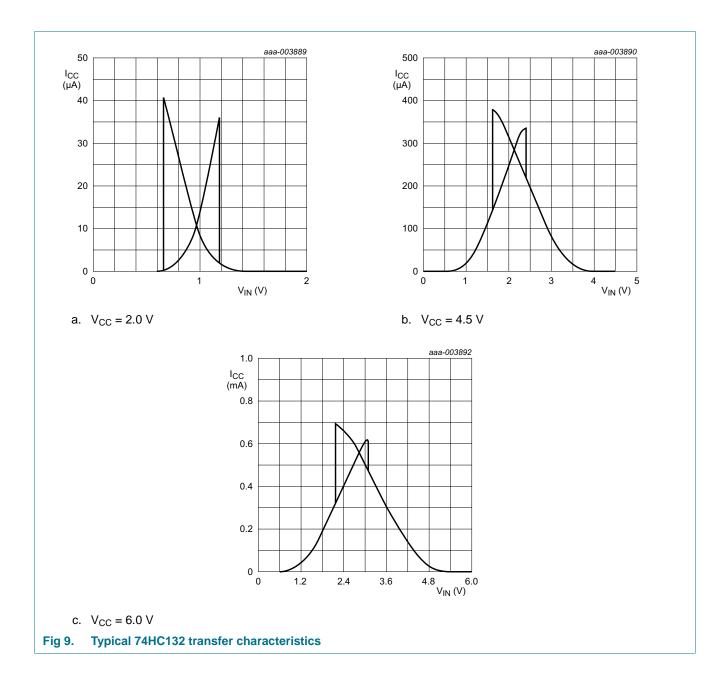
14. Transfer characteristics waveforms



Product data sheet

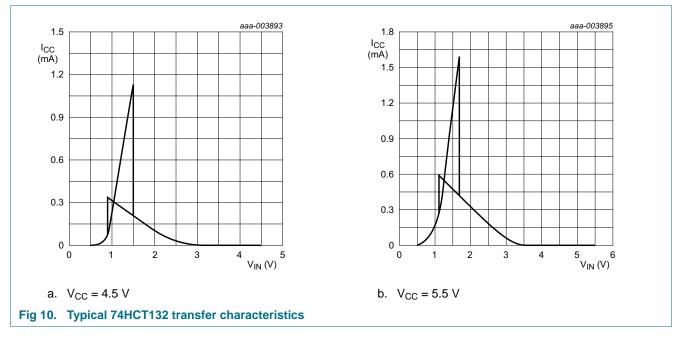
74HC132; 74HCT132

Quad 2-input NAND Schmitt trigger



74HC132; 74HCT132

Quad 2-input NAND Schmitt trigger



15. Application information

The slow input rise and fall times cause additional power dissipation, this can be calculated using the following formula:

 $P_{add} = f_i \times (t_r \times \Delta I_{CC(AV)} + t_f \times \Delta I_{CC(AV)}) \times V_{CC}$ where:

 P_{add} = additional power dissipation (μ W);

 $f_i = input frequency (MHz);$

 t_r = rise time (ns); 10 % to 90 %;

t_f = fall time (ns); 90 % to 10 %;

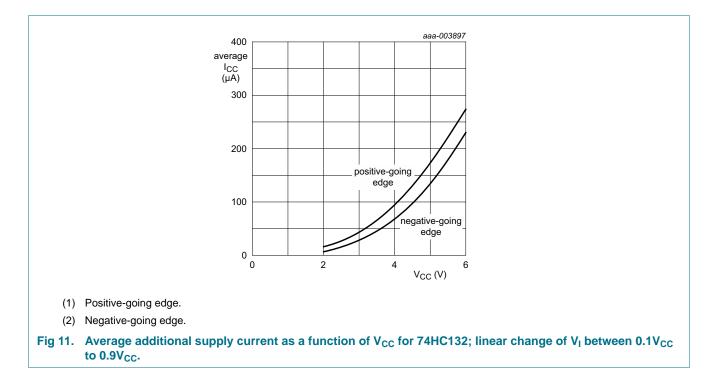
 $\Delta I_{CC(AV)}$ = average additional supply current (µA).

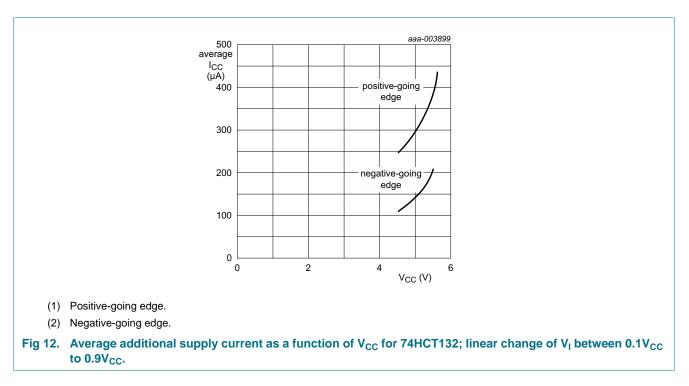
Average $\Delta I_{CC(AV)}$ differs with positive or negative input transitions, as shown in Figure 11 and Figure 12.

An example of a relaxation circuit using the 74HC132; 74HCT132 is shown in Figure 13.

74HC132; 74HCT132

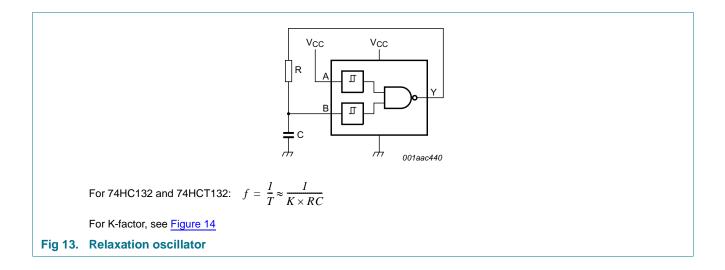
Quad 2-input NAND Schmitt trigger

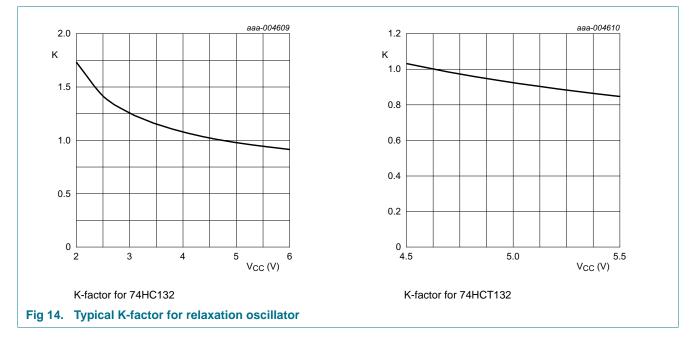




74HC132; 74HCT132

Quad 2-input NAND Schmitt trigger





Quad 2-input NAND Schmitt trigger

16. Package outline

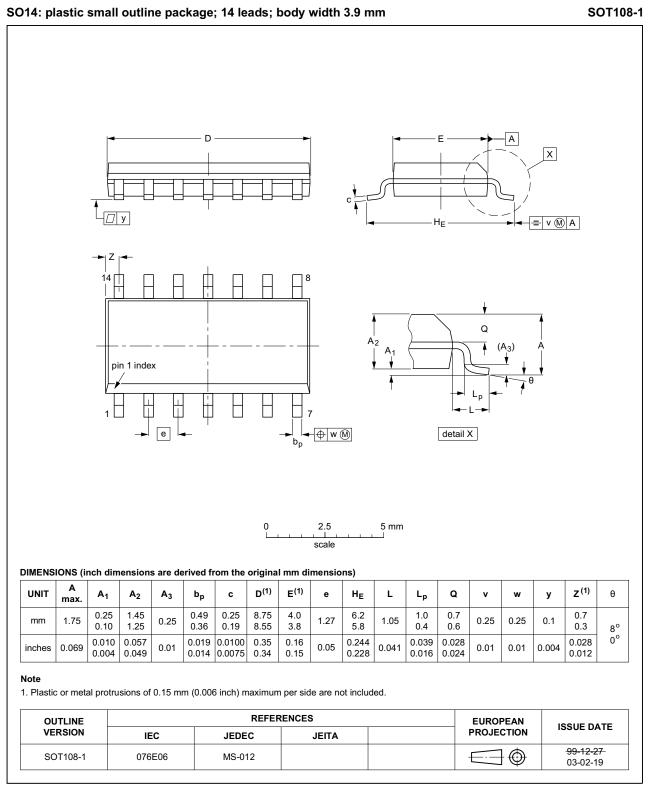


Fig 15. Package outline SOT108-1 (SO14)

74HC_HCT132

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Quad 2-input NAND Schmitt trigger

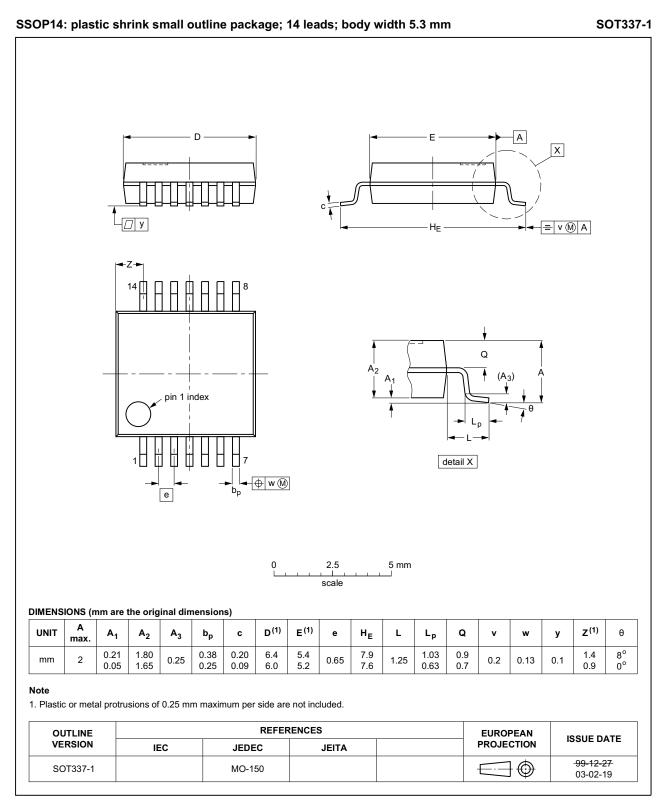


Fig 16. Package outline SOT337-1 (SSOP14)

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74HC_HCT132

Quad 2-input NAND Schmitt trigger

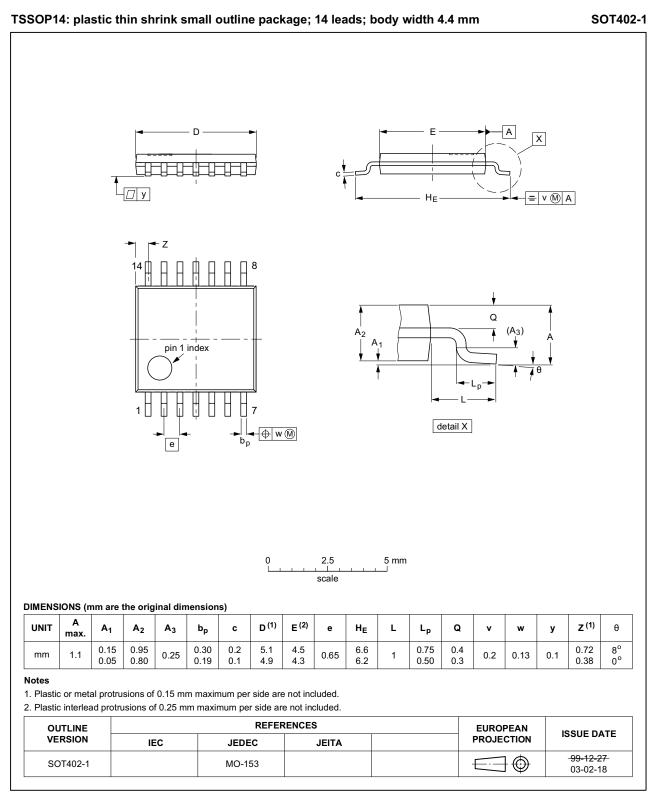


Fig 17. Package outline SOT402-1 (TSSOP14)

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74HC_HCT132

17. Abbreviations

Table 11. Abbreviations					
Acronym	Description				
CMOS	Complementary Metal-Oxide Semiconductor				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
HBM	Human Body Model				
MM	Machine Model				
TTL	Transistor-Transistor Logic				

18. Revision history

Table 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes				
74HC_HCT132 v.4	20151201	Product data sheet	-	74HC_HCT132 v.3				
Modifications:	• Type numbers 74HC132N and 74HCT132N (SOT27-1) removed.							
74HC_HCT132 v.3	20120830	Product data sheet	-	74HC_HCT132_CNV v.2				
Modifications:	 The format of this data of NXP Semiconduct 		gned to comply with	the new identity guidelines				
	 Legal texts have been 	en adapted to the new co	mpany name where	appropriate.				
	• Figure 14 added (typical K-factor for relaxation oscillator).							
74HC_HCT132_CNV v.2	19970826	Product specification	-	-				

19. Legal information

19.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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74HC HCT132

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